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SPECIFICATION FOR LCM MODULE

MODULE NO.: ABG240128N09-BIW-R DOC.REVISION 00

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
PREPARED BY (QA ENGINEER)		
CHECKED BY		
APPROVED BY		

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1. FUNCTIONS & FEATURES

1.1. Format : 240x128 Dots

1.2. LCD mode : STN/ Negative transmissive / Blue mode

1.3. Viewing direction : 6 o'clock

1.4. Driving scheme : 1/128 Duty cycle, 1/9 Bias

1.5. Power supply voltage(V_{DD}) : 5.0V

1.6. LCD driving voltage : 14.5V (reference voltage)

1.7. Operation temp : -20~70°C 1.8. Storage temp : -30~80°C 1.9. Backlight color : White

1.10.ROHS Standard

2. MECHANICAL SPECIFICATIONS

2.1. Module size : 144.0mm(L)*104.0mm(W)* 16.3max mm(H)

 2.2. Viewing area
 : 114.0mm(L)*64.0mm(W)

 2.3. Dot pitch
 : 0.45mm(L)*0.45mm(W)

 2.4. Dot size
 : 0.40mm(L)*0.40mm(W)

2.5. Weight : Approx.

3. BLOCK DIAGRAM

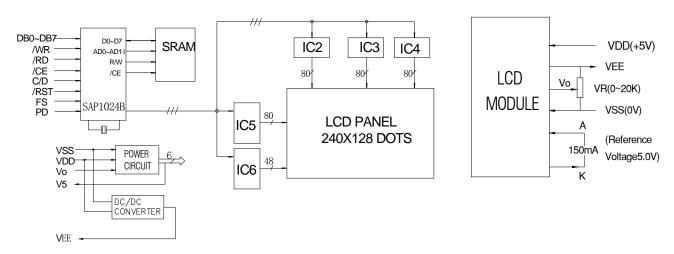


Figure 1. Block diagram



4. DIMENSIONAL OUTLINE

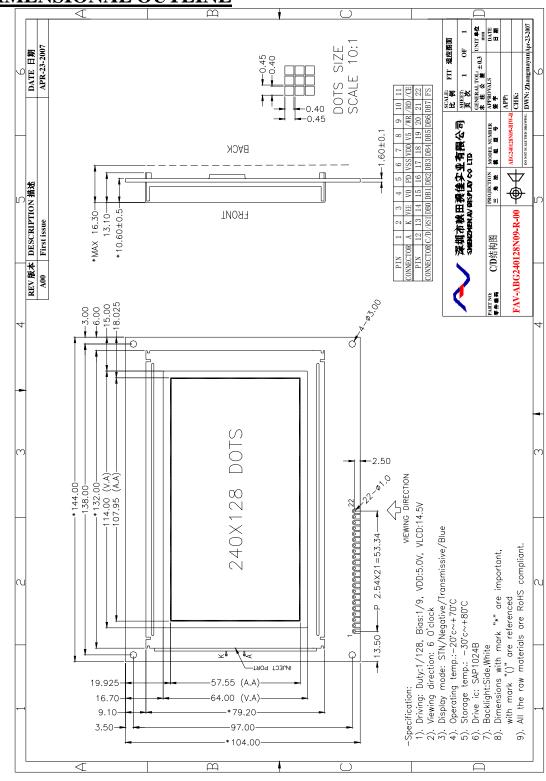


Figure 2. Dimensional outline



5. PIN DESCRIPTION

No.	Symbol	Function
1	A	Backlight supply voltage(+)
2	K	Backlight supply voltage(-)
3	VEE	Negative voltage output (-15V)> connect to the rest pin of trimpot
4	V0	Power supply for the LCD drive (-11V)> connect to adjust pin of trimpot
5	PD	Control pin for oscillation> connect to VDD
6	VSS	GND(0V)
7	VDD	Power supply for Logic(+5.0V)> also connect to the rest pin trimpot
8	V5	Supply voltage for LCD (Not connected)
9	/WR	Write signal
10	/RD	Read signal
11	/CE	Chip selection signal
12	C/D	Data or Instruction select signal(H: data register L: instruction register)
13	/RST	Reset signal
14-21	DB0~DB7	Data bus line
22	FS	Font selection terminal

6. MAXIMUM ABSOUTE LIMIT

Item	Symbol	MIN	MAX	Unit
Supply Voltage for Logic	$ m V_{DD}$	-0.3	7.0	V
Supply Voltage for LCD	V0	Vdd-19.0	V _{DD} +0.3	V
Input Voltage	Vin	-0.3	V _{DD} +0.3	V
Supply Current for Backlight	$I_F(Ta = 25^{\circ}C)$		150+150*20%	mA
Reverse Voltage for Backlight	$V_R(Ta = 25^{\circ}C)$		5	V
Operating Temperature	Тор	-20	70	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tst	-30	80	$^{\circ}\!\mathbb{C}$

7. ELECTRICAL CHARACTERISTICS

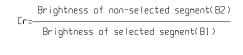
Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	V _{DD} -V _{SS}	$Ta = 25^{\circ}C$	4.75	5.0	5.25	V
Input High Voltage	VIH	Ta = 25°C	$0.7V_{\mathrm{DD}}$		V_{DD}	V
Input Low Voltage	VIL	Ta = 25°C	0		$0.3V_{\mathrm{DD}}$	V
Output High Voltage	Voh	$Ta = 25^{\circ}C$	2.4			V
Output Low Voltage	Vol	$Ta = 25^{\circ}C$			0.4	V
Supply Current	Idd	$Ta = 25^{\circ}C$		33	35	mA

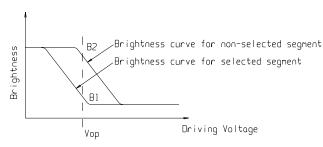
8. BACKLIGHT CHARACTERISTICS Ta = 25°C

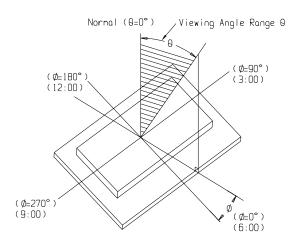
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF=150mA	3.3	3.5	3.7	V
Reverse Current	IR	VR=5V			90	uA
Luminous Intensity (Without LCD	Lv	IF=150mA	300			Cd/m ²
Wave length(Without LCD)	λρ	IF=150mA	X=0. 26 Y=0. 26		X=0.30 Y=0.30	
Color	white					

9. ELECTRO-OPTICAL CHARACTERISTICS ($V_{DD} = 5.0V$, Ta = 25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit	
On anatina Walter		Ta = -20°C	14.6	15.0	15.4		
Operating Voltage for LCD	Vlcd	$Ta = 25^{\circ}C$	14.1	14.5	14.9	V	
101 LCD		$Ta = 70^{\circ}C$	13.6	14.0	14.4		
Dognongo timo	Tr	Ta = 25°C		185		ms	
Response time	Tf	1a – 23 C		200		ms	
Contrast	Cr	$Ta = 25^{\circ}C$		4			
Vienine enele nonce	θ	C., > 2	-40		+40	deg	
Viewing angle range	ange Φ	Cr≥2	-40		+40	deg	

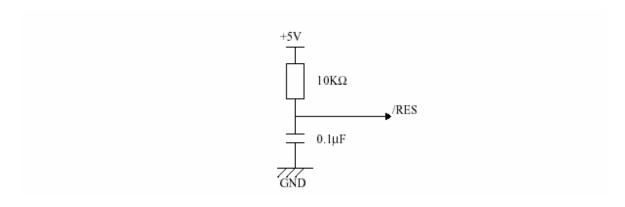






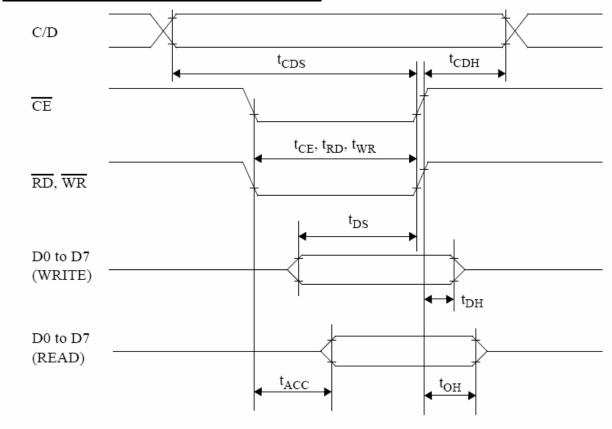


10. The /RES (RESET) Terminal
The SAP1024B may be reset by an external active low TTL signal from a MPU or other logic device or it may be reset using the following circuit





11. TIMING CHARACTERISTICS



Test Conditions(Unless Otherwise Noted, VDD = 5.0± 10%, Vss = 0V, Ta=-20 to 75°C)

Item	Symbol	Test Conditions	Min	Max	Unit
C/D Set-up Time	t _{CDS}	_	100	_	ns
C/DHold Time	t _{CDH}	_	10	_	ns
CE, RD, WR Pulse Width	t_{CE}, t_{RD}, t_{WR}	_	80	_	ns
Data Set-up Time	t _{DS}	_	80	_	ns
Data Hold Time	t _{DH}	_	40	_	ns
Access Time	t _{ACC}	_	_	150	ns
Output Hold Time	t _{OH}	_	10	50	ns



12. CONTROL AND DISPLAY INSTRUCTION

12: CONTROL 1111				
COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001 00100010 00100100	X address Data Low address	Y address 00H High address	Set Cursor Pointer Set Offset Register Set Address Pointer
SET CONTROL WORD	01000000 01000001 01000010 01000011	Low address Columns Low address Columns	High address 00H High address 00H	Set Text Home Address Set Text Area Set Graphic Home Address Set Graphic Area
MODE SET	1000*000 1000*001 1000*011 1000*100 10000*** 10001***	- - - - -	- - - -	OR mode EXOR mode AND mode Text Attribute mode Internal CG ROM mode External CG RAM mode
DISPLAY MODE	10010000 1001**10 1001**11 100101** 100110** 100111**	- - - - -	- - - - -	Display off Cusor on, blink off Cursor on, blink on Text on, graphic off Text off, graphic on Text on, graphic on
CURSOR PATTERN SELECT	10100000 10100001 10100010 10100011 1010010	- - - - - -	- - - - - - -	1-line cursor 2-line cursor 3-line cursor 4-line cursor 5-line cursor 6-line cursor 7-line cursor 8-line cursor
DATA AUTO READ/ WRITE	10110000 10110001 10110010	- - -	- - -	Set Data Auto Write Set Data Auto Read Auto Reset
DATA READ/WRITE	11000000 11000001 11000010 11000011 11000100 11000101	Data - Data - Data -	- - - - -	Data Write and Increment ADP Data Read and Increment ADP Data Write and Decrement ADP Data Read and Decrement ADP Data Write and Nonvariable ADP Data Read and Nonvariable ADP
SCREEN PEEK	11100000	-	-	Screen Peek
SCREEN COPY	11101000			Screen Copy
BIT SET/RESET	11110*** 1111*** 1111*000 1111*001 1111*010 1111*110 1111*110 1111*111	- - - - - - - -	-	Bit Reset Bit Set Bit 0 (LSB) Bit 1 Bit 2 Bit 3 Bit 4 Bit 5 Bit 6 Bit 7 (MSB)

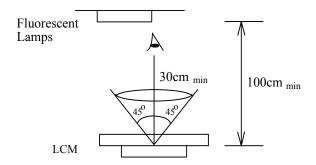


13.QUALITY SPECIFICATIONS

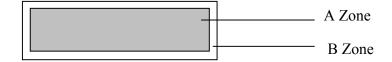
13.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Active display area (minimum viewing area). B Zone: Non-active display area (outside viewing area).

13.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling



Defect classification (Note: * is not including)

Classify		Item	Note	AQL
Major	Display state	Short or open circuit	1	0.65
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display	Background color deviation	2	1.0
	state	Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
		Protruded	12	
	Polarizer	Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	



Note on defect classification

No.	Item		Criterion				
1	Short or open circuit			No	ot allow		
	LC leakage						
	Flickering						
	No display						
	Wrong viewing direction						
	Wrong Back-light	1					
2	Contrast defect		Refe	er to a	pproval san	nple	
	Background color deviation						
3	Point defect, Black spot, dust (including Polarizer) $\phi = (X+Y)/2$	$\bigvee_{\widehat{X}} Y$		0.10 0.20 0.25	Point Size $\phi \le 0.10$ $0 < \phi \le 0.20$ $0 < \phi \le 0.25$ $5 < \phi \le 0.30$ $\phi > 0.30$	Acceptable Qty. Disregard 3 2 1 0	
			Uni	it: m	m		
4	Line defect, Scratch	$ \begin{array}{c} \downarrow \\ \downarrow \\ \downarrow \\ \downarrow \\ L \end{array} $ W	L 3.0≥ 2.0≥ 1.0≥	0. :L	ine W 015≥W 0.03≥W 0.05≥W 0.1>W 0.05 <w< td=""><td>Acceptable Qty. Disregard 2 1 Applied as point defect</td></w<>	Acceptable Qty. Disregard 2 1 Applied as point defect	
5	Rainbow	Not more than two color changes across the viewing area.					



No	Item	Criterion		
6	Chip Remark: X: Length direction Y: Short	Acceptable criterion $\begin{array}{c cccc} X & Y & Z \\ \hline & X & Y & Z \\ \hline & & \leq 2 & 0.5 \text{mm} & \leq t/2 \\ \hline \end{array}$		
	direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
		Acceptable criterion $\begin{array}{ c c c c c c c c c c c c c c c c c c c$		
		Acceptable criterion $\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		



No.	Item	Criterion			
7	Segment pattern $W = Segment \ width$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10 \text{mm is acceptable.}$ Y			
8	Back-light	(1) The color of backlight should correspond its specification.			
9	Soldering	(2) Not allow flickering (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead			
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire incide the flat cable. 			
11*	PCB	(4) Not allow exposed copper wire inside the flat cable.(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.			



No	Item	Criterion	
12	Protruded W: Terminal Width	Acceptable criteria: $Y \le 0.4$	
13	TAB	1. Position $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
		2 TAB bonding strength test TAB P (=F/TAB bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)	
14	Total no. of acceptable Defect	A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.	



13.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	48	
High temp. Operating	70°C	48	
Low temp. Storage	-30°C	48	No abnormalities
Low temp. Operating	-20°C	48	in functions
Humidity	40°C/ 90%RH	48	and appearance
Temp. Cycle	0°C ← 25°C →50°C	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance ,etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below $45\pm20\%$ RH), and in the area not exposed to direct sun light. The life time is not content the life time of the LED (for the life time of LED which decay only 50%,in the industry the experience value is 50000 hours, but there are not any experimentation data to support this).

13.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not make any modification on the PCB without consulting AV.



- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C+10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.



7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

AV LCDs and modules are not consumer products, but may be incorporated by AV's customers into consumer products or components thereof, AV does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of AV is limited to repair or replacement on the terms set forth below. AV will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between AV and the customer, AV will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with AV general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.